Gas Discharge Tubes CG6 Series



RoHS

CG6 Series



Agency Approvals

AGENCY	AGENCY FILE NUMBER			
91	E128662			
91	E320116			

Two Electrode GDT Graphical Symbol



Additional Information







Description

The Littelfuse CG6 series GDT is a miniature surfacemount device with a 3kA 8/20 surge rating. This ITU-T K.12 Class 1, Type 1 GDT provides protection against fast rising transients typically caused by nearby lightning events. Its low insertion loss and thus low off-state capacitance makes it compatible with high bandwidth applications up to the GHz RF range. This GDT's crowbarring characteristic protects sensitive ICs from surges as defined in ITU K.20/21/45 Basic and Enhanced Recommendations, GR-1089-CORE first level lightning Port Type 1,3, and 5, and IEC 61000-4-5, 2nd edition Level 5 and below. It is hermetically sealed using non-radioactive materials and is thus environmentally safe.

Features

- RoHS compliant and Lead-free
- Excellent Surge Withstanding Capability
- Excellent response to fast rising transients.
- Ultra Low Insertion Loss and low off-state capacitance for GHz bandwidth compatibility
- 3kA 8/20µs surge capability
 - Jability

Applications

- Broadband equipment
- CATV/Broadband equipment
- Data lines and Ethernet (up to 10GbE)
- xDSL equipment, including ADSL2, ADSL, VDSL, VDSL2 30a bandplan compatible
- IAD (Integrated Access Device)
- Set Top Box (STB)
- General telecom equipment

- Compact SMD package offered in two squared terminals
- Non-Radioactive
- Ultra Low capacitance (<0.3pF)
- Voltage Range 75V to 600V
- UL recognized
- Characterized according to ITU-T K.12 as a Class X, Type 1 GDT

• Embedded Multimedia Terminal Adapter (EMTA)

- RF Connector
- Multimedia over Coax Alliance (MoCA)
- Base Station RF
 antenna transmitter
- G.Fast 106MHz and 212 MHz bandplans compatible
- Aerospace and Automotive



Electrical Characteristics

	Device Specifications (at 25°C)					Life Ratings																	
Part	DC I	Breakd in Volts @100V/s	lown s ទ	Impulse Break- down in Volts (@100V/µs)	Impulse Break- down In Volts (@1 kV/µs)	Insulation Resistance	Capaci- tance (@1MHz)	Max Impulse Discharge Current (8/20µs)	Max Impulse Discharge Current (10/700µs)	AC Dischage Current (50Hz, 1sec)	AC Dischage Current (Single, 9 Cycles)	DC Holdover Voltage (<150ms)	Impulse Life (10/1000µs) (50A)										
Number	MIN	TYP	MAX	MAX		MIN	MAX			MIN	MIN		MIN										
CG675	60	75	90	600	700	1GΩ						52V											
CG690	72	90	108	600	700	@50V						52V											
CG6145	116	145	174	600	700	1GΩ 0.3pf @100V	10.01				52V												
CG6230	186	230	276	600	700		1GΩ 0 @100V	1GΩ					10 Shots				80V						
CG6250	200	250	300	600	700				1GΩ	1GΩ 0.3pf							0.0	(3kÅ) 1	10 Shots	24		80V	300
CG6300	240	300	360	650	800						0.3pt		(150A/6k\/) 2	зA	бА	135V	Shots						
CG6350	280	350	420	750	900				1 Shot at	(100, 001, 01, 01, 01, 01, 01, 01, 01, 01			135V										
CG6400	360	400	480	850	1000				JKA				135V										
CG6470	376	470	564	900	1100							135V											
CG6600	480	600	720	1000	1200	1GΩ@250V						135V											

Note:

1. 5 x (+) and 5 x (-) applications of 3kA 8/20 μs sec.

Product Characteristics

2. 5 x (+) and 5 x (-) applications of 150A 10/700 μs sec.

Materials	Device Tin Plated 17.5 ± 12.5 Microns Construction: Ceramic Insulator
Storage and Operational Temperature	-40 to +90°C

Typical Insertion Loss

@	1.0GHz = 0.03dB
@	1.4GHz = 0.06dB
@	1.8GHz = 0.09dB
@	2.0GHz = 0.11dB
@	2.4GHz = 0.13dB
@	2.8GHz = 0.15dB
@	3.1GHz = 0.17dB
@	3.5GHz = 0.19dB
@	4.0GHz = 0.22dB

Note: Insertion data for customer reference only, application testing needed for verification.

V-I Characteristic Curve

Characteristics of Gas Plasma -response to transient condition



impedance state once the voltage across the device falls below this level.

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Voltage Vs. Time Characteristic



Note: Tested per 1kV/µs waveform



Soldering Parameters - Reflow Soldering (Surface Mount Devices)

Reflow Co	ndition	Pb – Free assembly		
	-Temperature Min (T _{s(min)})	150°C		
Pre Heat	-Temperature Max (T _{s(max)})	200°C		
	-Time (Min to Max) (t _s)	60 – 180 secs		
Average ra (T _L) to pea	amp up rate (LiquidusTemp k	3°C/second max		
$T_{S(max)}$ to T_L	- Ramp-up Rate	5°C/second max		
Poflow	- Temperature (T _L) (Liquidus)	217°C		
nenow	- Temperature (t _L)	60 – 150 seconds		
PeakTemp	erature (T _P)	260 ^{+0/-5} °C		
Time with Temperatu	in 5°C of actual peak ire (t _p)	10 – 30 seconds		
Ramp-dow	vn Rate	6°C/second max		
Time 25°C	to peak Temperature (T _P)	8 minutes Max.		
Do not exc	ceed	260°C		



Device Dimensions





Recommended Soldering Pad Layout

Product Marking



Type Code					
Α	CG675				
В	CG690				
S	CG6145				
D	CG6230				
R	CG6250				
E	CG6300				
G	CG6350				
I	CG6400				
Р	CG6470				
V	CG6600				

Month Code					
Α	January				
В	February				
C	March				
D	April				
E	May				
F	June				
G	July				
Н	August				
I	September				
J	October				
К	November				
L	December				



Taping and Reel Specifications

ltem	Spec	ltem	Spec
Р	8.0 ± 0.1	Е	1.75 ± 0.1
P0	4.0 ± 0.1	D	1.50 + 0.1/-0.0
P2	2.0 ± 0.1	B0	4.5 ± 0.1
W	12.0 ± 0.3	KO	3.9 ± 0.1
F	5.5 ± 0.1	Т	0.4 ± 0.1
A0	3.9 ± 0.1	10P0	4.0 ± 0.2

330±4.0



Packaging Quantity: 2000 pcs per reel (13")

1 reels per inner box 10 inners box per carton 20,000 pcs per full carton





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